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IEC Secretariat 3, rue de Varembé CH-1211 Geneva 20 Switzerland Tel. +41 22 919 02 11

info@iec.ch www.iec.ch USB Implementers Forum, Inc. 3855 S.W. 153rd Drive Beaverton, OR 97003 United States of America Tel. +1 503-619-0426 Admin@usb.org

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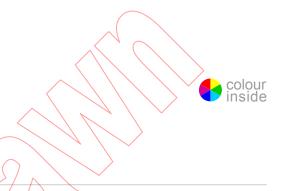
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Part 1-3: Common components – USB Type-C™ Cable and Connector

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Part 1-3: Common components – USB Type-C[™] Cable and Connector Specification

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